



# Product Change Notification

## 112720 - 00

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# Product Change Notification

**Change Notification #:** 112720 - 00  
**Change Title:** Intel® True Scale Fabric Host Channel Adapter QLE7340CK, Intel® True Scale Fabric Host Channel Adapter QLE7340LCK, Intel® True Scale Fabric Host Channel Adapter QLE7342CK

**PCN 112720-00, Label, Product Marking**

**QLE734x update regulatory markings for Korea and Canada**

**Date of Publication:** November 18, 2013

## Key Characteristics of the Change:

Label, Product Marking

## Forecasted Key Milestones:

|                                                                         |              |
|-------------------------------------------------------------------------|--------------|
| <b>Date of Samples Availability:</b>                                    | Nov 18, 2013 |
| <b>Date Customer Must be Ready to Receive Post-Conversion Material:</b> | Nov 25, 2013 |
| <b>Date of First Availability of Post-Conversion Material:</b>          | Nov 25, 2013 |

*The date of "First Availability of Post-Conversion Material" is the projected date that a customer may expect to receive the Post-Conversion Materials. This date is determined by the projected depletion of inventory at the time of the PCN publication. The depletion of inventory may be impacted by fluctuating supply and demand, therefore, although customers should be prepared to receive the Post-Converted Materials on this date, Intel will continue to ship and customers may continue to receive the pre-converted materials until the inventory has been depleted.*

## Description of Change to the Customer:

| Affected Product Code | Former Product Code | Product Description                                      |
|-----------------------|---------------------|----------------------------------------------------------|
| QLE7342CK             | IB6413601-03        | Intel® True Scale Fabric Host Channel Adapter QLE7342CK  |
| QLE7340CK             | IB6413601-04        | Intel® True Scale Fabric Host Channel Adapter QLE7340CK  |
| QLE7340LCK            | IB6413601-06        | Intel® True Scale Fabric Host Channel Adapter QLE7340LCK |

## Overview of Changes

- Korean Marking:** The Korea Communications Commission (KCC) EMC/RF/Telecom authority has been renamed as Ministry of Science, ICT & Future Planning (MSIP). As of July 1, 2013, the KCC Certificate/Registration number structure has been modified such that KCC as a part of cert/registration number will be replaced by MSIP for all new registrations. In addition, Class designation in the product marking is no longer required and has been removed.
  - From: KCC-REM-CPU-XXXXXXXXXXXXXXXX (class)
  - To: MSIP-REM-CPU-XXXXXXXXXXXXXXXX
- Canadian Marking:** As of August 2013, per ICES-003 Issue 5, *Interference-Causing Equipment Standard, Information Technology Equipment (ITE) – Limits and methods of measurement*, the Canadian Product Marking has changed to include the French *Norme sur le Matériel Brouilleur* (NMB) for new products. Existing models may retain the existing marking per ICES-003 Issue 4. Therefore, this change will be phased in over time.
  - From: ICES-003 class
  - To: CAN ICES-3 (class)/NMB-3 (class)
- Product documentation:** Updated the Read Me First document to remove the Korean Logo, the Taiwanese Logo, Manufacturer and Country of Origin from the document, as these are not required in this document.

## Board Change Details

- The Korean Registration number has been changed in the Silkscreen for future builds. Existing products will have a label over the old Korean Marking to implement this change:
  - From: KCC-REM-CPU-QLE7342(A)
  - To: MSIP-REM-CPU-QLE7342
- The Canadian marking has been changed in the Silkscreen for future builds. The existing product marking remains acceptable. Therefore, this change will be phased in over time.
  - From: ICES-003 Class A
  - To: CAN ICES-3 (A)/NMB-3(A)

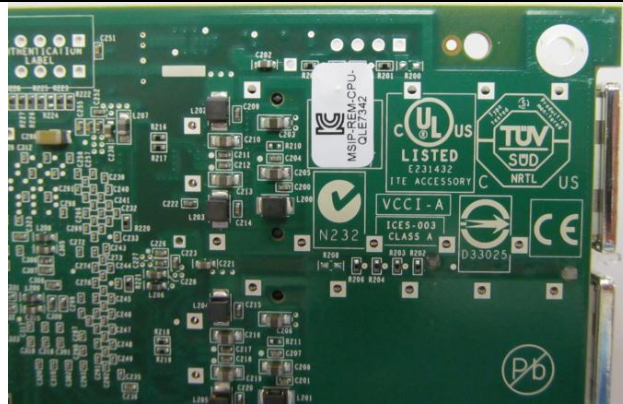
Figure 1. Bottom Side View of Board

From

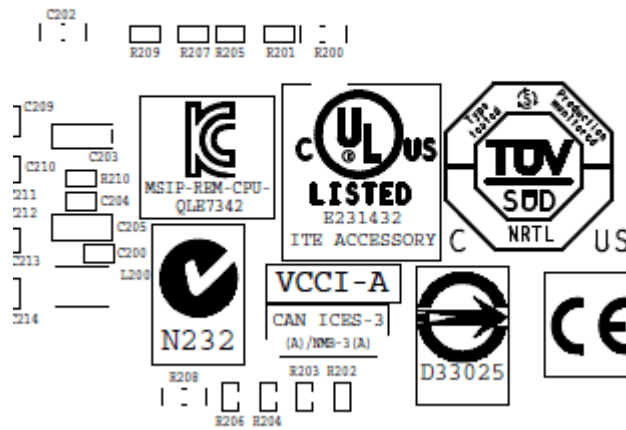


Note: QSFP port count and bracket size varies by product type

To



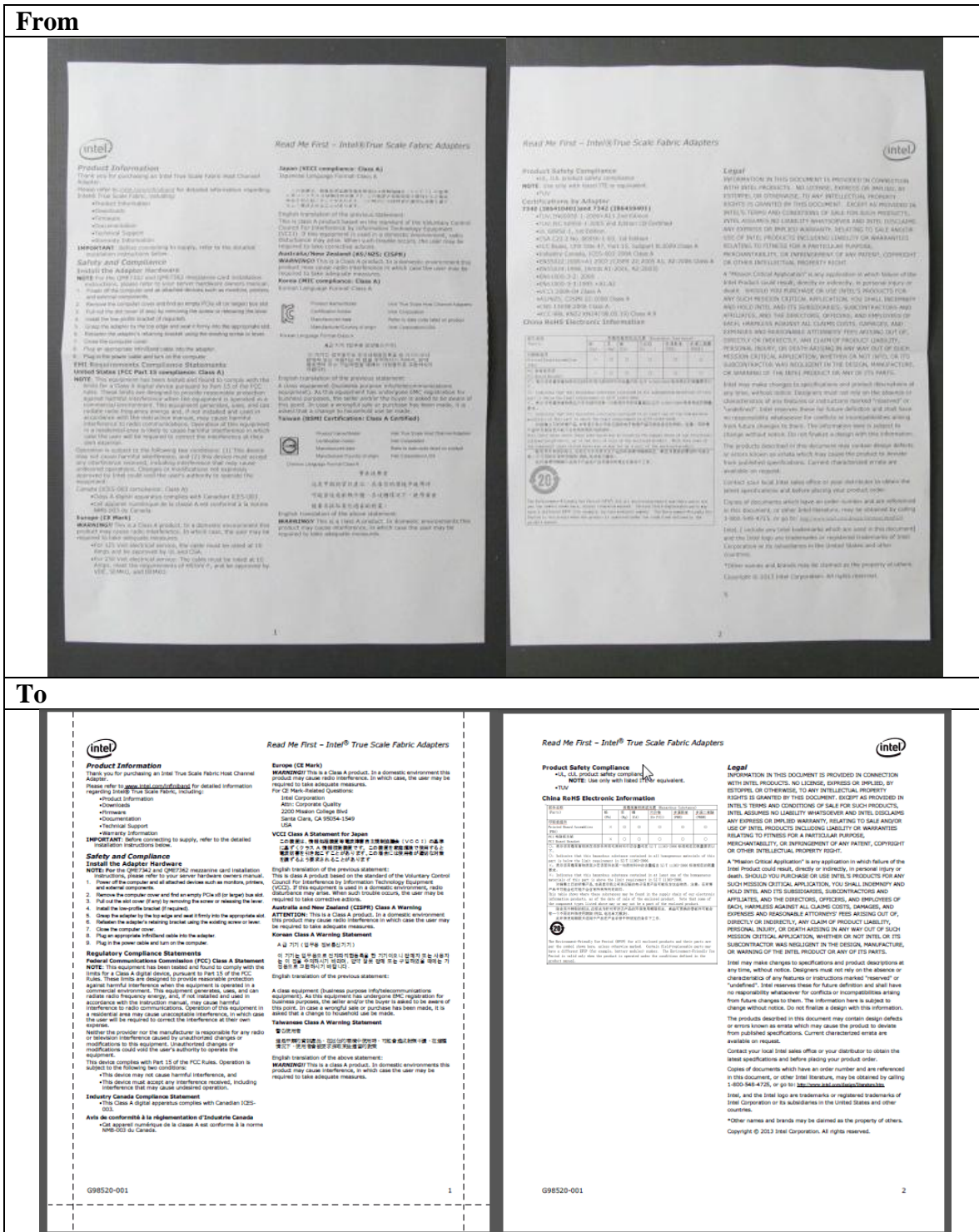
OR



# Product Documentation/Literature Change Details

## 1. Removed Korean and Taiwanese logos and Manufacturer Information

### Figure 2. Product Documentation/Literature Change



## Single Unit Carton Label Change Details

1. Updated the Korean KC registration number from KCC-REM-CPU-QLE7342 to MSIP-REM-CPU-QLE7342.

**Figure 3. Single Unit Carton Label Changes**

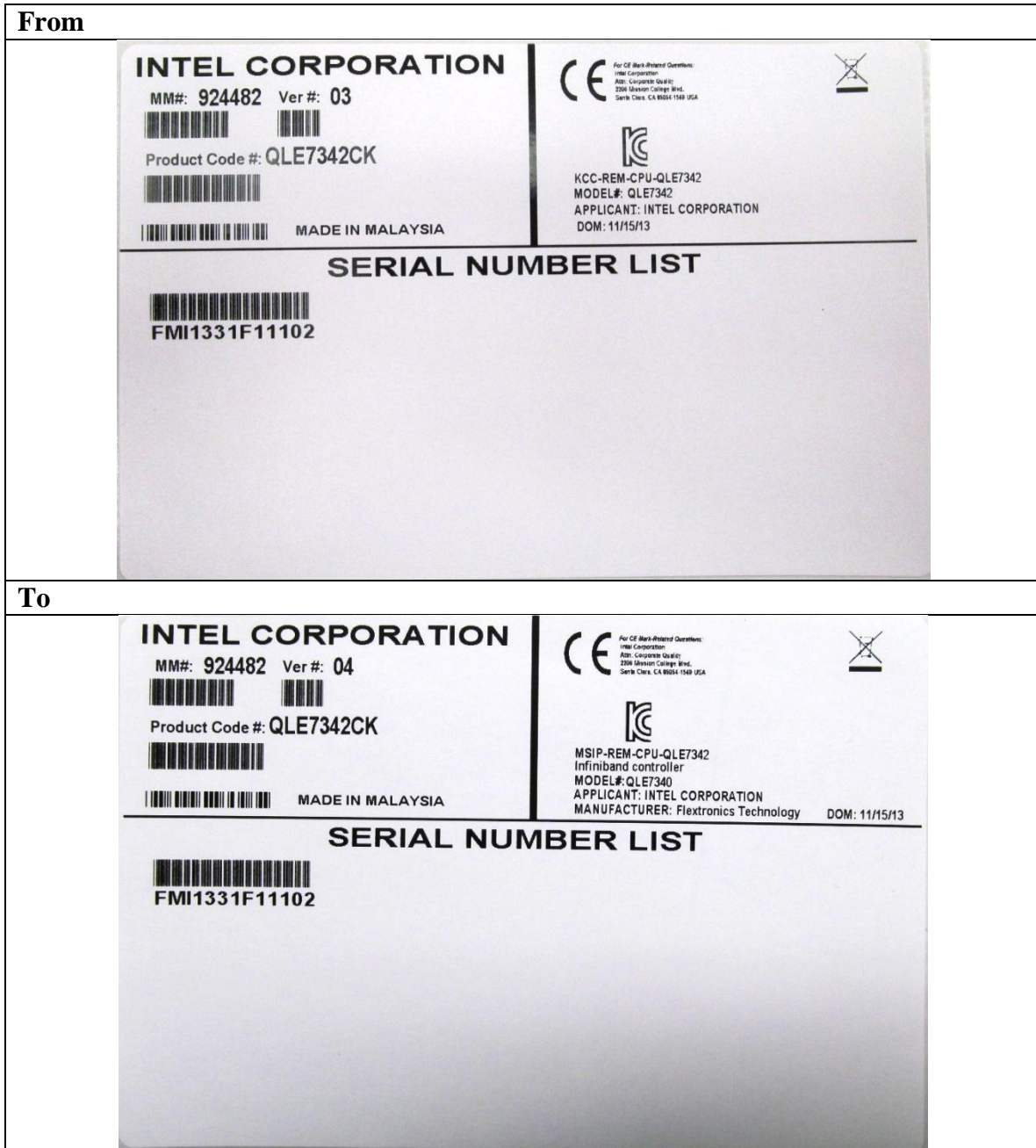
| From                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |
|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
|  <p>The original label features the KC logo and CE mark. Text includes: KCC-REM-CPU-QLE7342, MODEL#: QLE7342, APPLICANT: INTEL CORPORATION, DOM: 11/15/13, MM#: 924483, Version#: 03, Product Code: QLE7340CK, and S/N: FMI1331F11102. It also contains a crossed-out recycling symbol and 'ASSEMBLED IN MALAYSIA' with a barcode.</p>                                                               |
| To                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
|  <p>The updated label features the KC logo and CE mark. Text includes: MSIP-REM-CPU-QLE7342, Infiniband controller, MODEL#: QLE7340, APPLICANT: INTEL CORPORATION, MANUFACTURER: Flextronics Technology, DOM: 11/15/13, MM#: 924483, Version#: 04, Product Code: QLE7340CK, and S/N: FMI1331F11102. It also contains a crossed-out recycling symbol and 'ASSEMBLED IN MALAYSIA' with a barcode.</p> |

**Note: The product code shown is an example for the purpose of illustration – refer to the Products Affected table for actual product codes.**

## Overpack Carton Label Change Details

- Updated the Korean KC registration number from KCC-REM-CPU-QLE7342 to MSIP-REM-CPU-QLE7342.

**Figure 4. Overpack Carton Label Changes**



**Note:** The product code shown is an example for the purpose of illustration – refer to the Products Affected table for actual product codes.

## Customer Impact of Change and Recommended Action:

There are no impacts to fit or function. There are minor impacts to form as visible labeling.

There is no change to the Intel MM Number.

Please contact your local Intel Field Sales Representative if you have any further questions about this change.

Milestone dates are estimates and subject to change based on business and operational conditions.

## Products Affected / Intel Ordering Codes:

| Product Code | MM#    | Pre Change Top Assembly | Post Change Top Assembly |
|--------------|--------|-------------------------|--------------------------|
| QLE7342CK    | 924482 | IB6413601-03 Rev H      | IB6413601-03 Rev J       |
| QLE7340CK    | 924483 | IB6413601-04 Rev G      | IB6413601-04 Rev H       |
| QLE7340LCK   | 924486 | IB6413601-06 Rev F      | IB6413601-06 Rev G       |

## PCN Revision History:

**Date of Revision:**

November 18, 2013

**Revision Number:**

00

**Reason:**

Originally Published PCN